

FQPF85N06-VB Datasheet

N-Channel 60-V (D-S) MOSFET

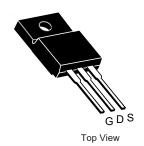
| PRODUCT SUMMARY | | | |
|---------------------|----------------------------------|---------------------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) ^a | |
| 60 | 0.010 at V _{GS} = 10 V | 70 | |
| 00 | 0.012 at V _{GS} = 4.5 V | 55 | |

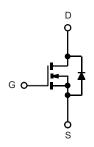
FEATURES

- 175 °C Junction Temperature
- TrenchFET® Power MOSFET
- Material categorization:









| N-Channel | MOSFFT |
|-----------|--------|

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 | 5 °C, unless other | wise noted) | | | |
|---|-------------------------|-----------------------------------|--------------------------------------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | |
| Ocation on Davis Ocament (T., 475 90)b | T _C = 25 °C | I- | 70 | | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 100 °C | - I _D | 50° | | |
| Pulsed Drain Current | | I _{DM} | 200 | A | |
| Continuous Source Current (Diode Conduction) | | I _S | 50ª | | |
| Avalanche Current | | I _{AS} | 50 | | |
| Single Avalanche Energy (Duty Cycle ≤ 1 %) | L = 0.1 mH | E _{AS} | 125 | mJ | |
| Maximum Dayyar Disaination | T _C = 25 °C | P _D | 136 | W | |
| Maximum Power Dissipation | T _A = 25 °C |] 'D [| 3 ^b , 8.3 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Marrian una livration de Amelianda | t ≤ 10 sec | R _{thJA} | 15 | 18 | °C/W |
| Maximum Junction-to-Ambient ^a | Steady State | | 40 | 50 | |
| Maximum Junction-to-Case | | R _{thJC} | 0.85 | 1.1 | |

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- $c.\ t \leq 10\ s.$



| Parameter | Symbol | Test Conditions | Min. | Typ.a | Max. | Unit | |
|---|---------------------|--|------|----------|----------|------|--|
| Static | • | | | <u>'</u> | <u> </u> | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 250 μA | 60 | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1 | 2 | 3 | V | |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | | | ± 100 | nA | |
| | | V _{DS} = 60 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μА | |
| | İ | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 10 V | 60 | | | Α | |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.010 | | | |
| | | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.016 | | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C | | 0.020 | | Ω | |
| | | V _{GS} = 4.5 V, I _D = 15 A | | 0.012 | | | |
| Forward Transconductance ^b | 9 _{fs} | $V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$ | | 60 | | S | |
| Dynamic | | | | <u>'</u> | | | |
| Input Capacitance | C _{iss} | | | 2650 | | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 470 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 225 | | | |
| Total Gate Charge ^c | Qg | | | 47 | 70 | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 10 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | | | 12 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | |
| Rise Time ^c | t _r | V_{DD} = 30 V, R_L = 0.6 Ω | | 15 | 25 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 35 | 50 | ns | |
| Fall Time ^c | t _f | | | 20 | 30 | | |
| Source-Drain Diode Ratings and Cha | aracteristics (| T _C = 25 °C) | | | · | | |
| Pulsed Current | I _{SM} | | | | 70 | Α | |
| Diode Forward Voltage | V _{SD} | I _F = 20 A, V _{GS} = 0 V | | 1 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | I _F = 20 A, di/dt = 100 A/μs | | 45 | 100 | ns | |

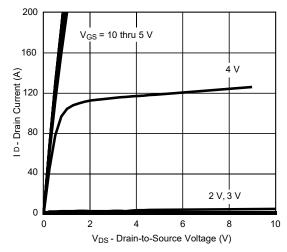
Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2~\%$.
- c. Independent of operating temperature.

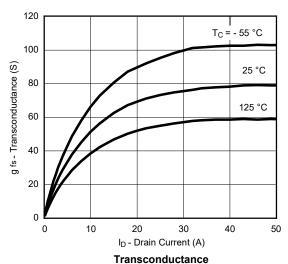
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

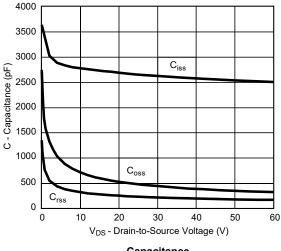


TYPICAL CHARACTERISTICS (25 °C unless noted)

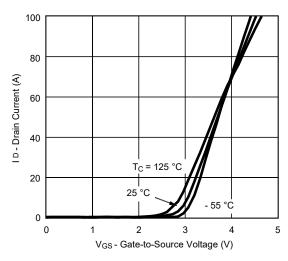


Output Characteristics

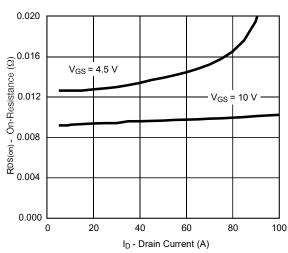




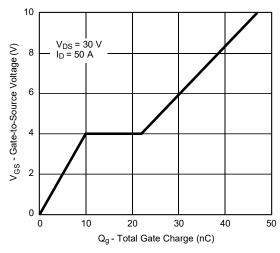
Capacitance



Transfer Characteristics



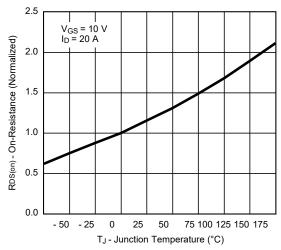
On-Resistance vs. Drain Current



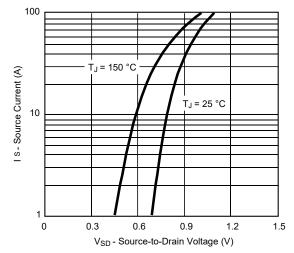
Gate Charge



TYPICAL CHARACTERISTICS (25 °C unless noted)



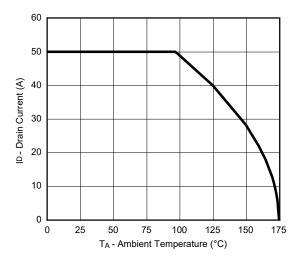
On-Resistance vs. Junction Temperature

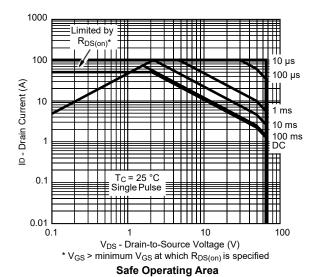


Source-Drain Diode Forward Voltage



THERMAL RATINGS





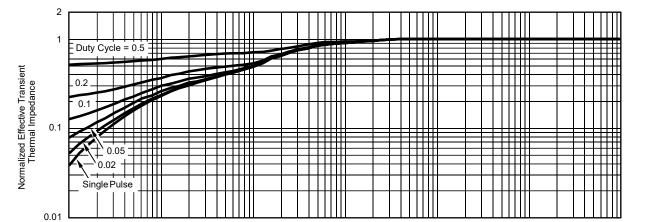
10

100

Maximum Drain Current vs. Ambient Temperature

10⁻³

10⁻²



Normalized Thermal Transient Impedance, Junction-to-Case

10-1

Square Wave Pulse Duration (s)

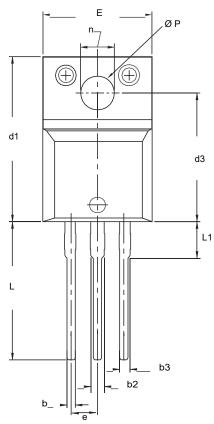
服务热线:400-655-8788

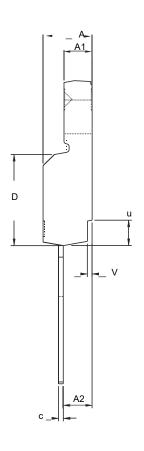
10-4

5



TO-220 FULLPAK (HIGH VOLTAGE)





| | MILLI | METERS | INC | HES |
|------|----------|--------|-----------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 4.570 | 4.830 | 0.180 | 0.190 |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 |
| b | 0.622 | 0.890 | 0.024 | 0.035 |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 |
| С | 0.440 | 0.629 | 0.017 | 0.025 |
| D | 8.650 | 9.800 | 0.341 | 0.386 |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 |
| Е | 10.360 | 10.630 | 0.408 | 0.419 |
| е | 2.54 BSC | | 0.100 BSC | |
| L | 13.200 | 13.730 | 0.520 | 0.541 |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 |
| n | 6.050 | 6.150 | 0.238 | 0.242 |
| ØΡ | 3.050 | 3.450 | 0.120 | 0.136 |
| u | 2.400 | 2.500 | 0.094 | 0.098 |
| ٧ | 0.400 | 0.500 | 0.016 | 0.020 |

Notes

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.



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